



PSMN102-200Y

N-channel TrenchMOS SiliconMAX standard level FET

Rev. 03 — 16 March 2011

Product data sheet

1. Product profile

1.1 General description

SiliconMAX standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

1.2 Features and benefits

- Higher operating power due to low thermal resistance
- Suitable for high frequency applications due to fast switching characteristics

1.3 Applications

- Class D amplifier
- Motion control
- DC-to-DC converters
- Switched-mode power supplies

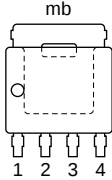
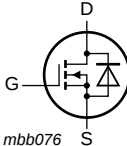
1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$T_j \geq 25\text{ °C}$; $T_j \leq 150\text{ °C}$	-	-	200	V
I_D	drain current	$T_{mb} = 25\text{ °C}$; $V_{GS} = 10\text{ V}$; see Figure 1 ; see Figure 3	-	-	21.5	A
P_{tot}	total power dissipation	$T_{mb} = 25\text{ °C}$; see Figure 2	-	-	113	W
Static characteristics						
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = 10\text{ V}$; $I_D = 12\text{ A}$; $T_j = 25\text{ °C}$; see Figure 9 ; see Figure 10	-	86	102	mΩ
Dynamic characteristics						
Q_{GD}	gate-drain charge	$V_{GS} = 10\text{ V}$; $I_D = 12\text{ A}$; $V_{DS} = 100\text{ V}$; see Figure 11 ; see Figure 12	-	10.1	-	nC

2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		
2	S	source		
3	S	source		
4	G	gate		
mb	D	mounting base; connected to drain		

SOT669 (LFPAK)

3. Ordering information

Table 3. Ordering information

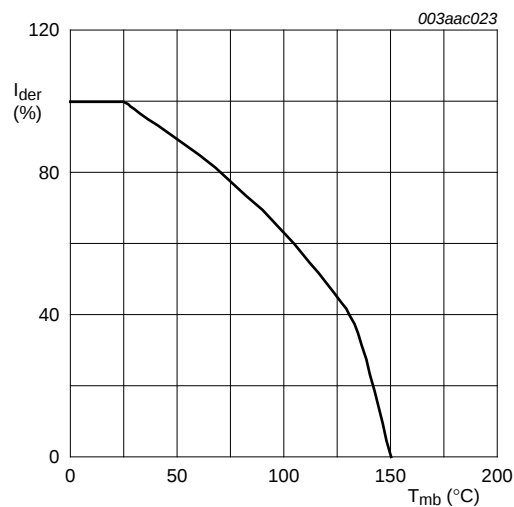
Type number	Package		
	Name	Description	Version
PSMN102-200Y	LFPAK	plastic single-ended surface-mounted package (LFPAK); 4 leads	SOT669

4. Limiting values

Table 4. Limiting values

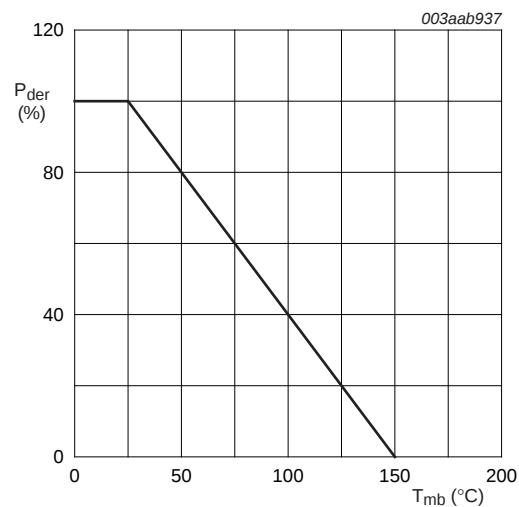
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage	$T_j \geq 25\text{ °C}$; $T_j \leq 150\text{ °C}$	-	200	V
V_{DGR}	drain-gate voltage	$T_j \geq 25\text{ °C}$; $T_j \leq 150\text{ °C}$; $R_{GS} = 20\text{ k}\Omega$	-	200	V
V_{GS}	gate-source voltage		-20	20	V
I_D	drain current	$V_{GS} = 10\text{ V}$; $T_{mb} = 25\text{ °C}$; see Figure 1 ; see Figure 3	-	21.5	A
		$V_{GS} = 10\text{ V}$; $T_{mb} = 100\text{ °C}$; see Figure 1	-	13.6	A
I_{DM}	peak drain current	pulsed; $t_p \leq 10\text{ }\mu\text{s}$; $T_{mb} = 25\text{ °C}$; see Figure 3	-	65	A
P_{tot}	total power dissipation	$T_{mb} = 25\text{ °C}$; see Figure 2	-	113	W
T_{stg}	storage temperature		-55	150	°C
T_j	junction temperature		-55	150	°C
Source-drain diode					
I_S	source current	$T_{mb} = 25\text{ °C}$	-	52	A
I_{SM}	peak source current	pulsed; $t_p \leq 10\text{ }\mu\text{s}$; $T_{mb} = 25\text{ °C}$	-	208	A
Avalanche ruggedness					
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$V_{GS} = 10\text{ V}$; $T_{j(\text{init})} = 25\text{ °C}$; $I_D = 10.8\text{ A}$; $V_{sup} \leq 200\text{ V}$; unclamped; $t_p = 0.14\text{ ms}$; $R_{GS} = 50\text{ }\Omega$	-	202	mJ



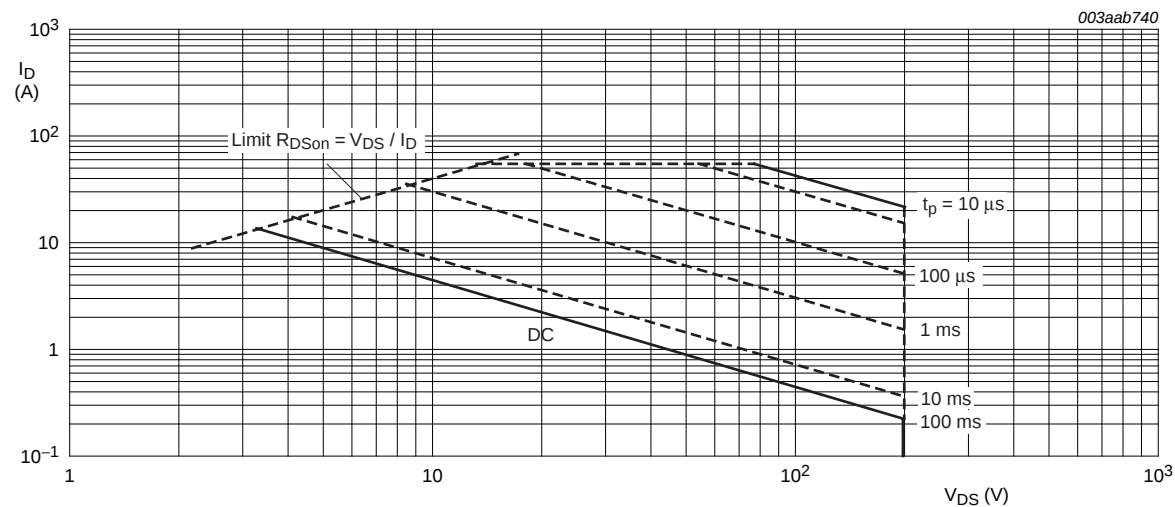
$$I_{der} = \frac{I_D}{I_{D(25^{\circ}\text{C})}} \times 100\%$$

Fig 1. Normalized continuous drain current as a function of mounting base temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}\text{C})}} \times 100\%$$

Fig 2. Normalized total power dissipation as a function of solder point temperature



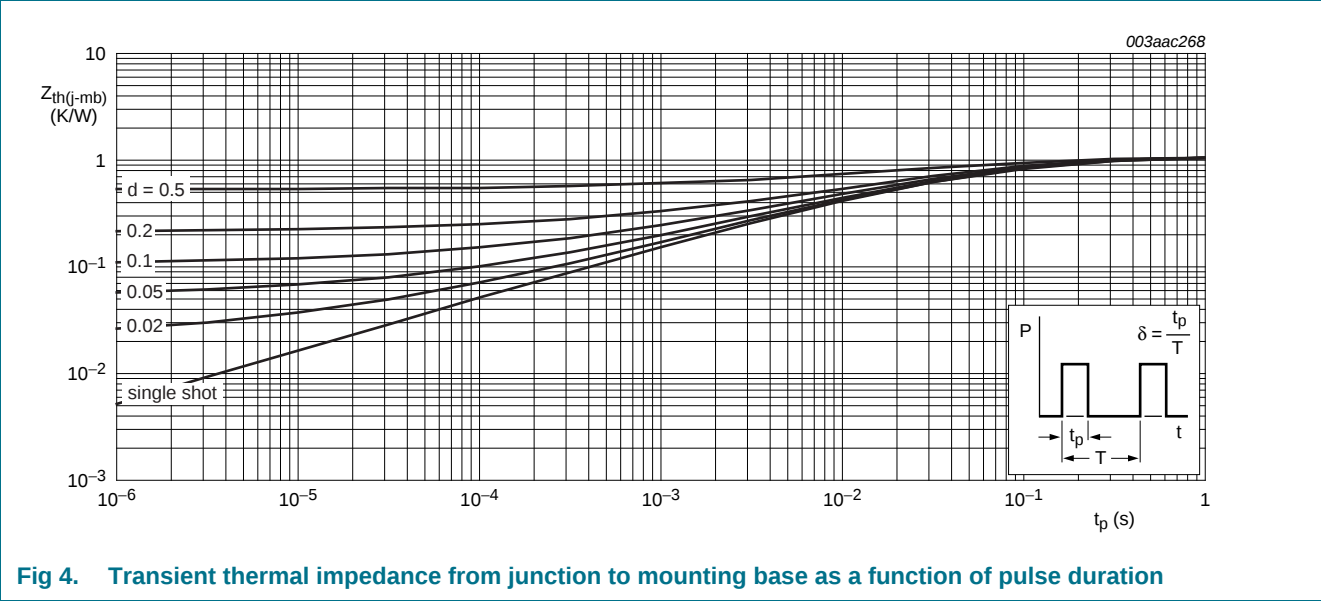
$$T_{mb} = 25^{\circ}\text{C}; I_{DM} \text{ is single pulse}$$

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	Mounted on a printed-circuit board; vertical in still air; see Figure 4	-	-	1.1	K/W



6. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _J = 25 °C	200	-	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _J = -55 °C	178	-	-	V
V _{GS(th)}	gate-source threshold voltage	I _D = 1 mA; V _{DS} = V _{GS} ; T _J = 25 °C; see Figure 7 ; see Figure 8	2	3	4	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _J = 150 °C; see Figure 7 ; see Figure 8	1	-	-	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _J = -55 °C; see Figure 7 ; see Figure 8	-	-	4.4	V
I _{DSS}	drain leakage current	V _{DS} = 160 V; V _{GS} = 0 V; T _J = 25 °C	-	-	1	μA
		V _{DS} = 160 V; V _{GS} = 0 V; T _J = 150 °C	-	-	100	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _J = 20 °C	-	-	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _J = 20 °C	-	-	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 12 A; T _J = 25 °C; see Figure 9 ; see Figure 10	-	86	102	mΩ
		V _{GS} = 10 V; I _D = 12 A; T _J = 150 °C; see Figure 9 ; see Figure 10	-	206	245	mΩ
R _G	gate resistance	f = 1 MHz	-	1.1	-	Ω
Dynamic characteristics						
Q _{G(tot)}	total gate charge	I _D = 12 A; V _{DS} = 100 V; V _{GS} = 10 V; see Figure 11 ; see Figure 12	-	30.7	-	nC
Q _{GS}	gate-source charge		-	6.3	-	nC
Q _{GD}	gate-drain charge		-	10.1	-	nC
V _{GS(pl)}	gate-source plateau voltage	I _D = 12 A; V _{DS} = 100 V; see Figure 11 ; see Figure 12	-	4.6	-	V
C _{iss}	input capacitance	V _{DS} = 30 V; V _{GS} = 0 V; f = 1 MHz; T _J = 25 °C; see Figure 13	-	1568	-	pF
C _{oss}	output capacitance		-	170	-	pF
C _{rss}	reverse transfer capacitance		-	55	-	pF
t _{d(on)}	turn-on delay time	V _{DS} = 100 V; R _L = 5.8 Ω; V _{GS} = 10 V; R _{G(ext)} = 5.6 Ω	-	14.2	-	ns
t _r	rise time		-	29.5	-	ns
t _{d(off)}	turn-off delay time		-	33	-	ns
t _f	fall time		-	28	-	ns
Source-drain diode						
V _{SD}	source-drain voltage	I _S = 12 A; V _{GS} = 0 V; T _J = 25 °C; see Figure 14	-	0.9	1.2	V
t _{rr}	reverse recovery time	I _S = 20 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V; V _{DS} = 30 V	-	143	-	ns
Q _r	recovered charge	I _S = 20 A; dI _S /dt = -100 A/μs; V _{GS} = 0 V	-	268	-	nC

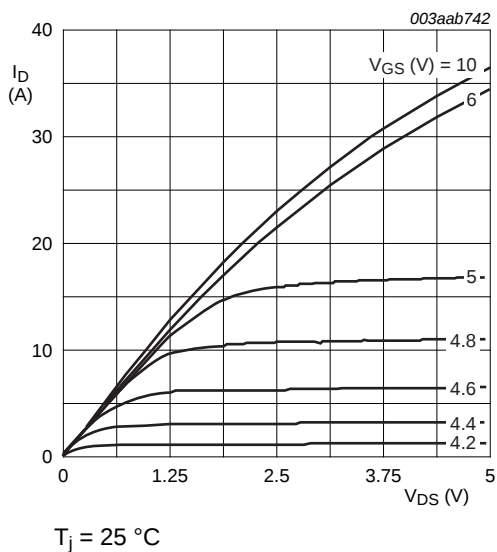


Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values

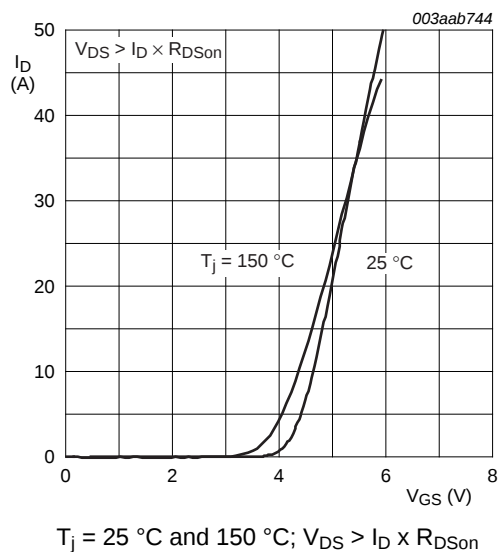


Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values

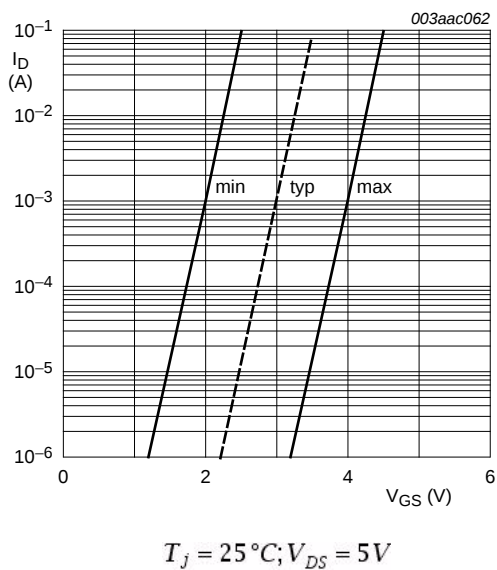


Fig 7. Sub-threshold drain current as a function of gate-source voltage

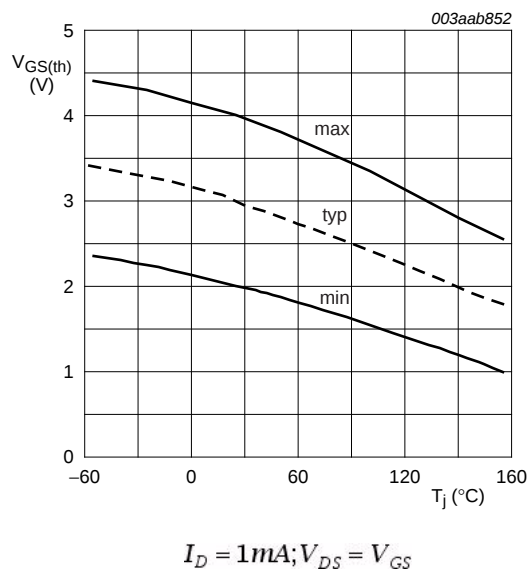


Fig 8. Gate-source threshold voltage as a function of junction temperature

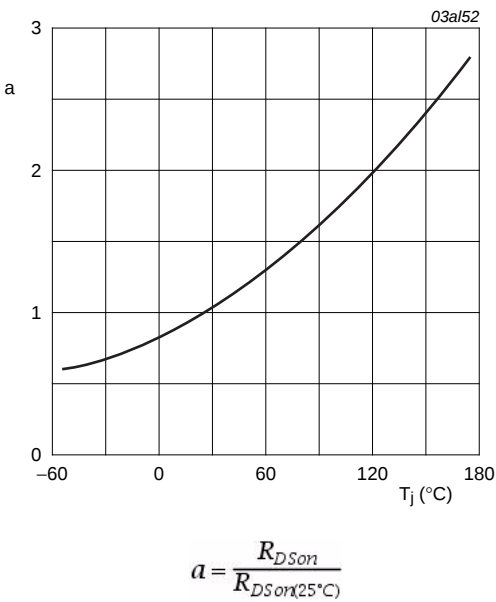


Fig 9. Normalized drain-source on-state resistance factor as a function of junction temperature

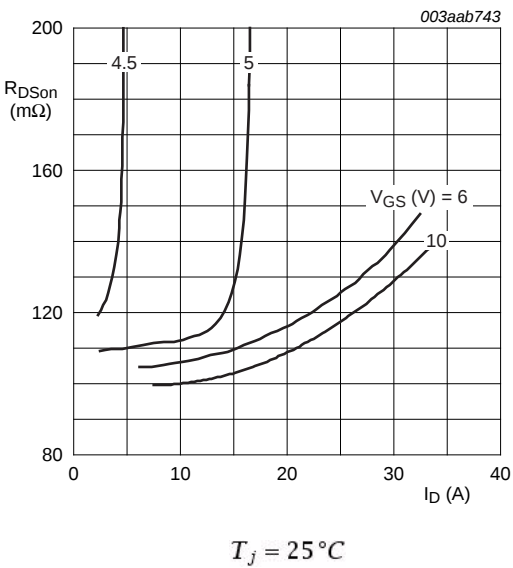


Fig 10. Drain-source on-state resistance as a function of drain current; typical values

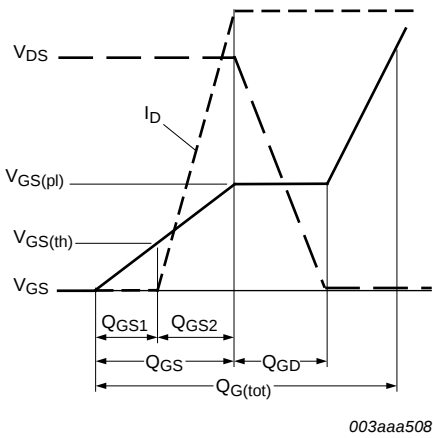


Fig 11. Gate charge waveform definitions

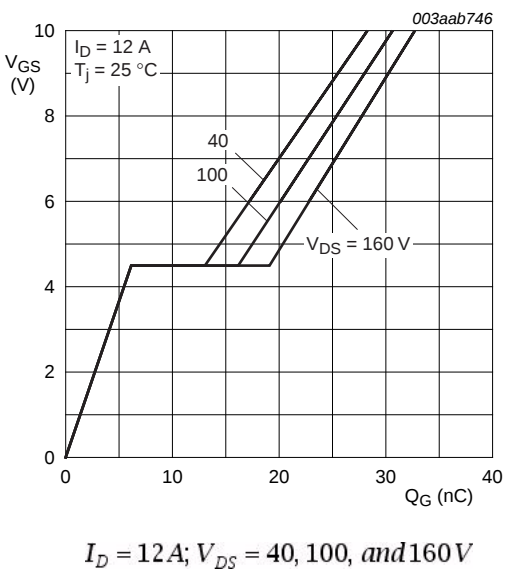


Fig 12. Gate-source voltage as a function of gate charge; typical values

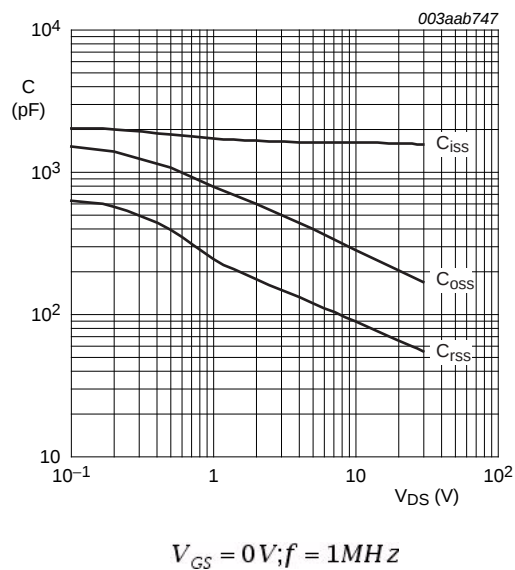


Fig 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

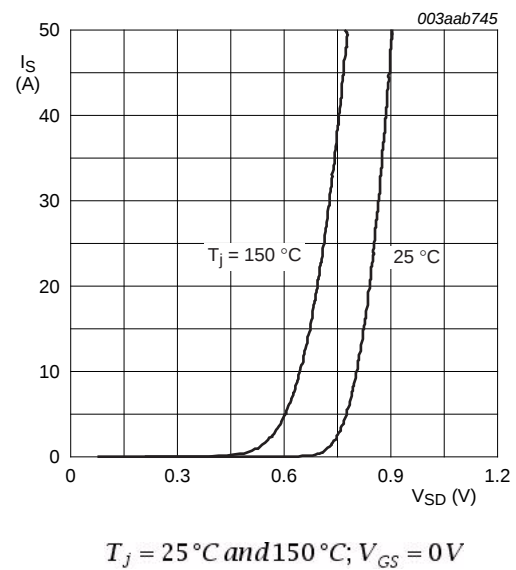


Fig 14. Source current as a function of source-drain voltage; typical values

7. Package outline

Plastic single-ended surface-mounted package (LPAK); 4 leads

SOT669

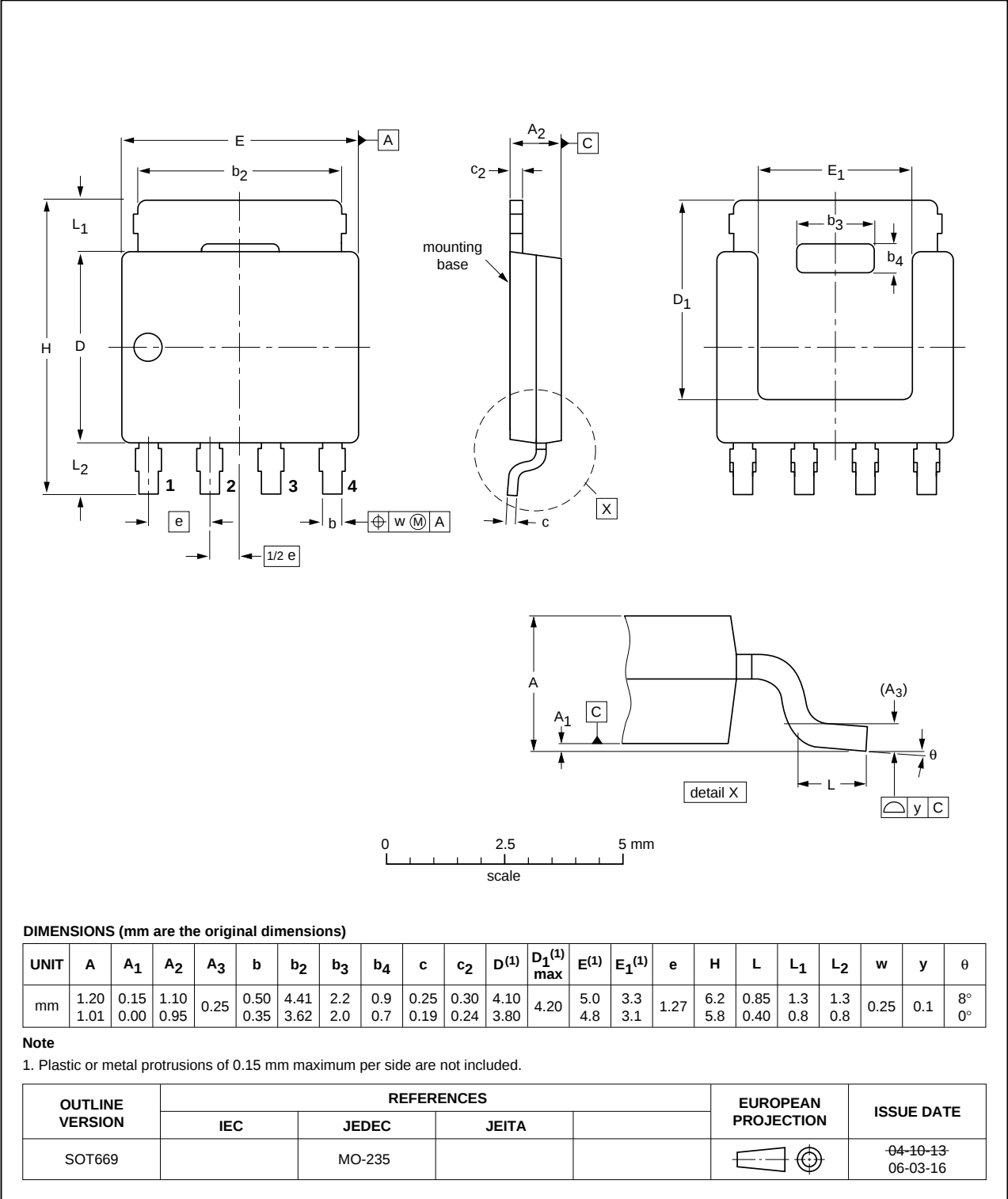


Fig 15. Package outline SOT669 (LPAK)

8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN102-200Y v.3	20110316	Product data sheet	-	PSMN102-200Y v.2
Modifications:	• Various changes to content.			
PSMN102-200Y v.2	20101220	Product data sheet	-	PSMN102-200Y v.1

9. Legal information

9.1 Data sheet status

Document status ^{[1] [2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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